

1N6843

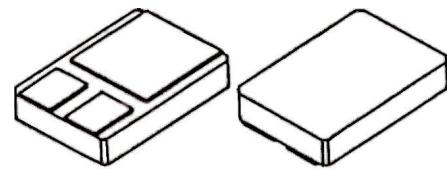
DESIGNER'S DATA SHEET

FEATURES:

- Low Profile Ceramic SMD
- High Surge Rating
- Low Reverse Leakage Current
- Low Forward Voltage
- Seam Welded Package
- Low Capacitance
- Ultrasonic Aluminum Wire Bonds

**100 VOLTS, 10 AMP
 DUAL SCHOTTKY
 COMMON CATHODE
 CENTERTAP RECTIFIER**

SMD-0.5



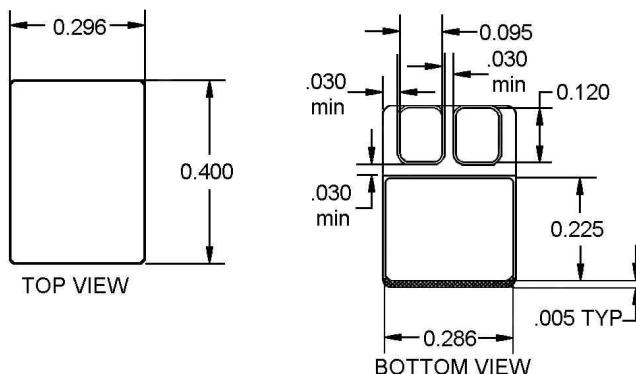
MAXIMUM RATINGS (per leg)

RATING	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse and DC Blocking Voltage 1N6843	V_{RRM} V_{RWN} V_R	100	Volts
Average Rectified Forward Current (Resistive Load, 60Hz, Sine Wave, TA = 25°C)	I_o	10	Amps
Peak Surge Current (8.3 ms Pulse, TA = 25°C, per leg)	I_{FSM}	200	Amps
Operating & Storage Temperature	Top & Tstg	-55 to +150	°C
Maximum Thermal Resistance Junction to Case, each individual diode Junction to Case Note 1	$R_{\theta JC}$	2.8 1.7	°C /W

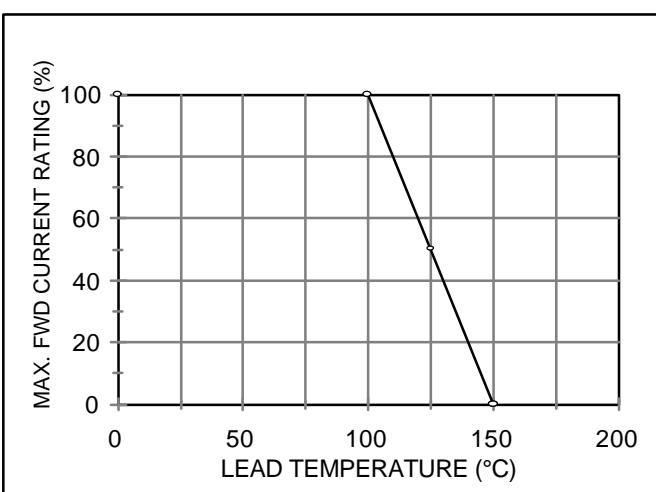
*Note 1: Both legs tied together
 11/1199*

ELECTRICAL CHARACTERISTICS (per leg)

CHARACTERISTICS	SYMBOL	MAX.	UNIT
Instantaneous Forward Voltage Drop ($I_F = 3$ Adc, $T_A = 25^\circ\text{C}$, 300us Pulse) ($I_F = 5$ Adc, $T_A = 25^\circ\text{C}$, 300μs Pulse) ($I_F = 10$ Adc, $T_A = 25^\circ\text{C}$, 300μs Pulse)	V_F	0.75 0.80 0.93	Vdc
Instantaneous Forward Voltage Drop ($I_F = 5$ Adc, $T_A = 100^\circ\text{C}$, 300μs Pulse) ($I_F = 5$ Adc, $T_A = -55^\circ\text{C}$, 300μs Pulse)	V_F	0.65 0.90	Vdc
Reverse Leakage Current (Rated VR, $T_A = 25^\circ\text{C}$, 300μs pulse minimum)	I_R	50	μA
Reverse Leakage Current (Rated VR, $T_A = 100^\circ\text{C}$, 300μs pulse minimum)	I_R	5	mA
Junction Capacitance $V_R = 10\text{Vdc}$, $T_A = 25^\circ\text{C}$, $f = 1\text{ MHz}$	C_J	300	Pf

CASE OUTLINE: SMD-0.5

TYPICAL OPERATING CURVES

(TA=25°C Unless otherwise specified)


1N6843 VF vs. IF (per die)
